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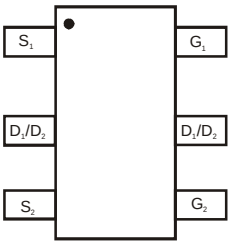
Features

- Low Gate Charge
- Low $R_{DS(ON)}$:
  - 28mΩ @V_{GS} = 4.5V
  - 32mΩ @V_{GS} = 2.5V
  - 40mΩ @V_{GS} = 1.8V
- Low Input/Output Leakage
- **Lead Free By Design/RoHS Compliant (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **"Green" Device (Note 4)**

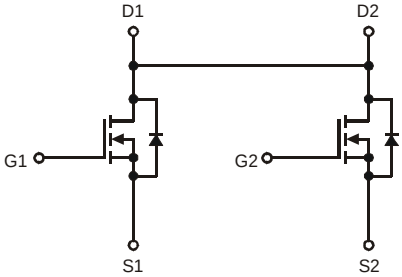
Mechanical Data

- Case: SOT-26
- Case Material - Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.008 grams (approximate)



TOP VIEW

TOP VIEW
Pin Configuration



Equivalent Circuit

Maximum Ratings @T_A = 25℃ unless otherwise specified

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	20	V
Gate-Source Voltage		V_{GSS}	±8	V
Drain Current (Note 1) Continuous	T_A = 25℃ T_A = 70℃	I_D	4.2 3.2	A
Pulsed Drain Current (Note 2)		I_{DM}	30	A

Thermal Characteristics @T_A = 25℃ unless otherwise specified

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	P_D	0.98	W
Thermal Resistance, Junction to Ambient (Note 1) t ≤10s	$R_{\theta JA}$	128	°C /W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Notes:
1. Device mounted on 1"x1", FR-4 PC board with 2 oz. Copper and test pulse width t ≤10s.
2. Repetitive Rating, pulse width limited by junction temperature.
3. No purposefully added lead.
4. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

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Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
STATIC CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	20	—	—	V	I_D = 250μA, V_{GS} = 0V
Zero Gate Voltage Drain Current	I_{DSS}	—	—	1	μA	V_{DS} = 20V, V_{GS} = 0V
Gate-Body Leakage Current	I_{GSS}	—	—	±100	nA	V_{DS} = 0V, V_{GS} = ±8V
Gate Threshold Voltage	$V_{GS(th)}$	0.5	—	0.9	V	V_{DS} = V_{GS}, I_D = 250μA
Static Drain-Source On-Resistance (Note 5)	$R_{DS\ (ON)}$	—	22 25 31	28 32 40	mΩ	V_{GS} = 4.5V, I_D = 8.2A V_{GS} = 2.5V, I_D = 3.3A V_{GS} = 1.8V, I_D = 2.0A
Forward Transfer Admittance	$\|Y_{FS}\|$	—	7	—	S	V_{DS} = 10V, I_D = 4A
Diode Forward Voltage (Note 5)	V_{SD}	—	0.7	0.9	V	I_S = 2.25A, V_{GS} = 0V
DYNAMIC CHARACTERISTICS (Note 6)						
Input Capacitance	C_{iss}	—	856	—	pF	V_{DS} = 10V, V_{GS} = 0V f = 1.0MHz
Output Capacitance	C_{oss}	—	83	—	pF	
Reverse Transfer Capacitance	C_{rss}	—	78	—	pF	
Gate Resisitance	R_G	—	1.32	—	Ω	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz
SWITCHING CHARACTERISTICS						
Total Gate Charge	Q_g	—	8.3	—	nC	V_{GS} = 4.5V, V_{DS} = 10V, I_D = 8.2A
Gate-Source Charge	Q_{gs}	—	1.3	—	nC	
Gate-Drain Charge	Q_{gd}	—	3.1	—	nC	
Turn-On Delay Time	$t_{D(on)}$	—	8.4	—	ns	V_{DD} = 10V, V_{GS} = 4.5V, R_L = 10Ω, R_G = 6Ω
Turn-On Rise Time	t_r	—	8.2	—	ns	
Turn-Off Delay Time	$t_{D(off)}$	—	40.4	—	ns	
Turn-Off Fall Time	t_f	—	8.9	—	ns	

Notes: 5. Test pulse width t = 300ms.
6. Guaranteed by design. Not subject to production testing.

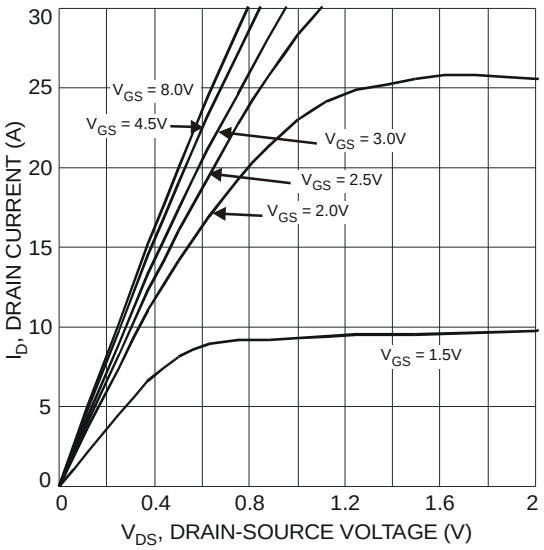

Fig. 1 Typical Output Characteristics

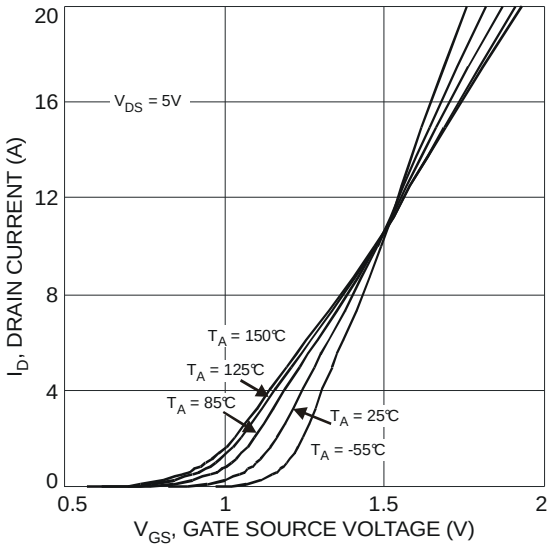

Fig. 2 Typical Transfer Characteristics

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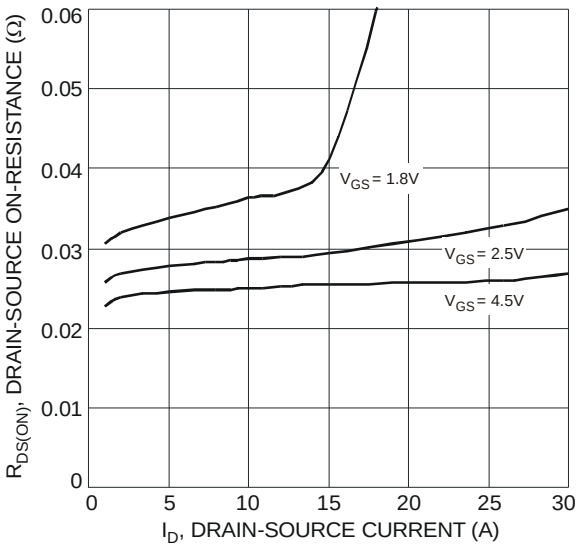

Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

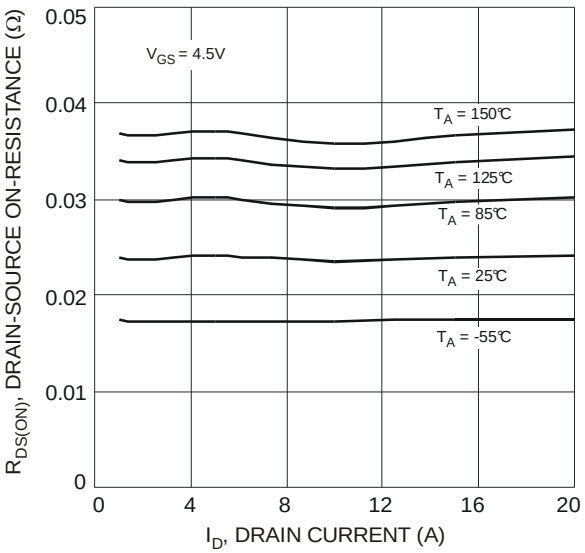

Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

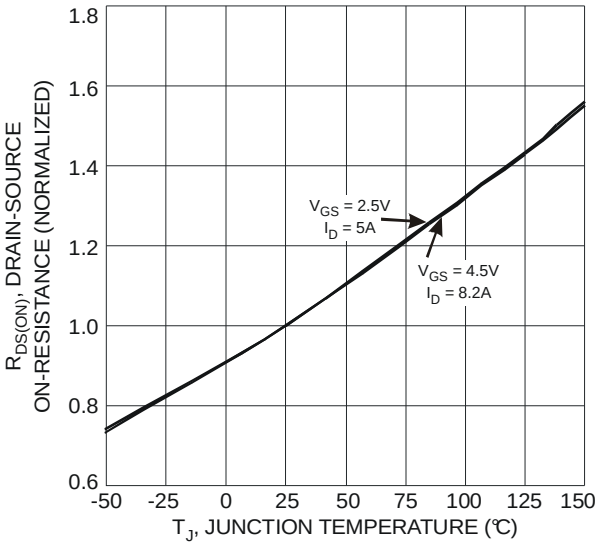

Fig. 5 On-Resistance Variation with Temperature

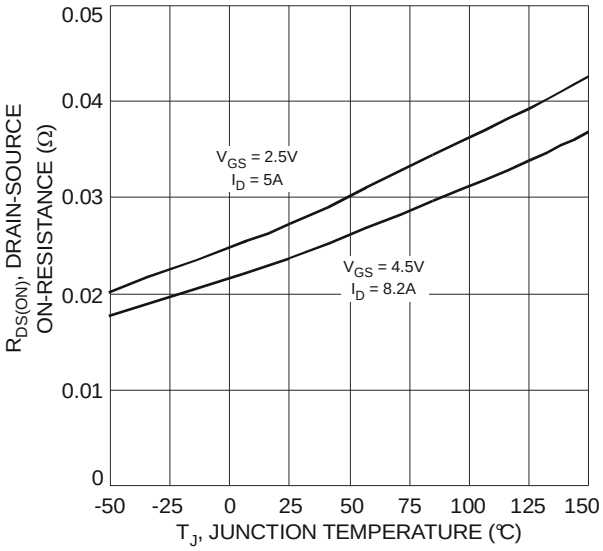

Fig. 6 On-Resistance Variation with Temperature

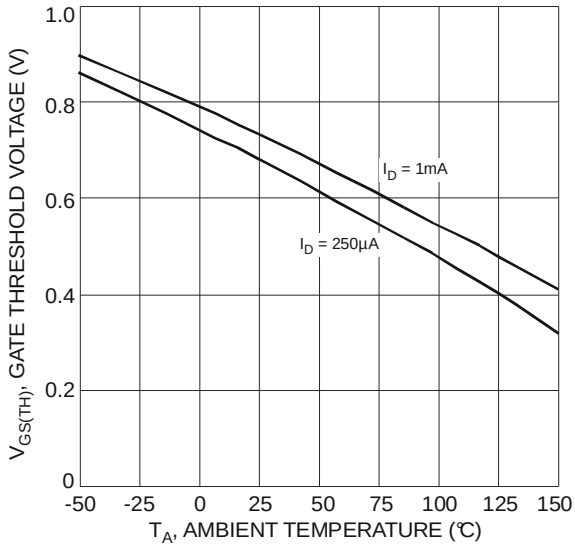

Fig. 7 Gate Threshold Variation vs. Ambient Temperature

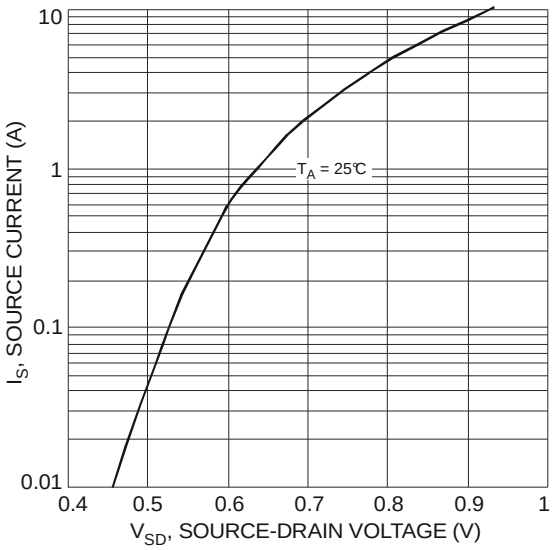

Fig. 8 Diode Forward Voltage vs. Current

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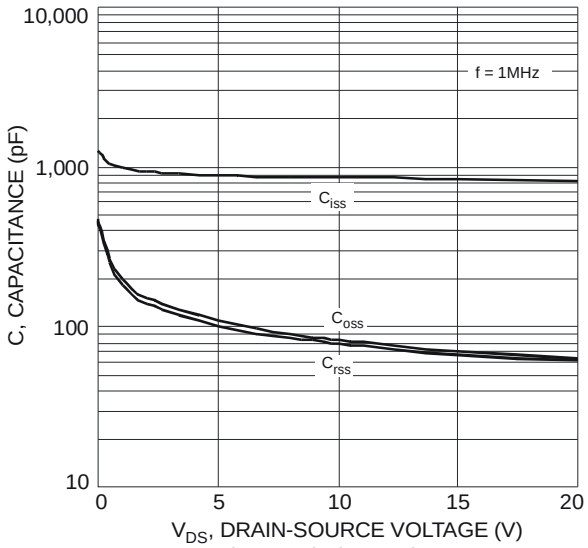


Fig. 9 Typical Capacitance

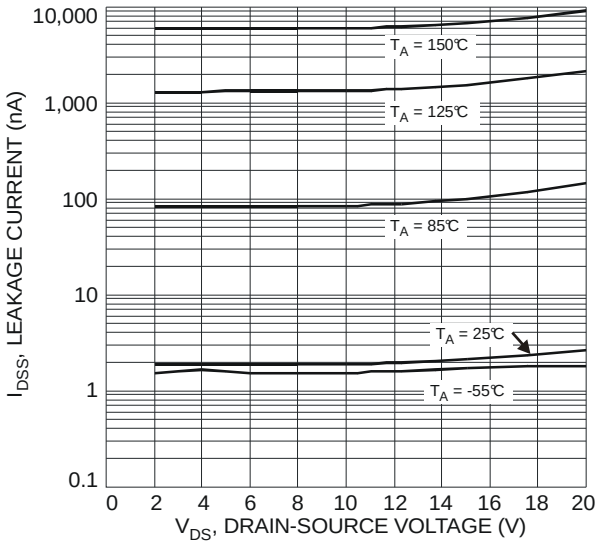


Fig. 10 Typical Drain-Source Leakage Current vs. Drain-Source Voltage

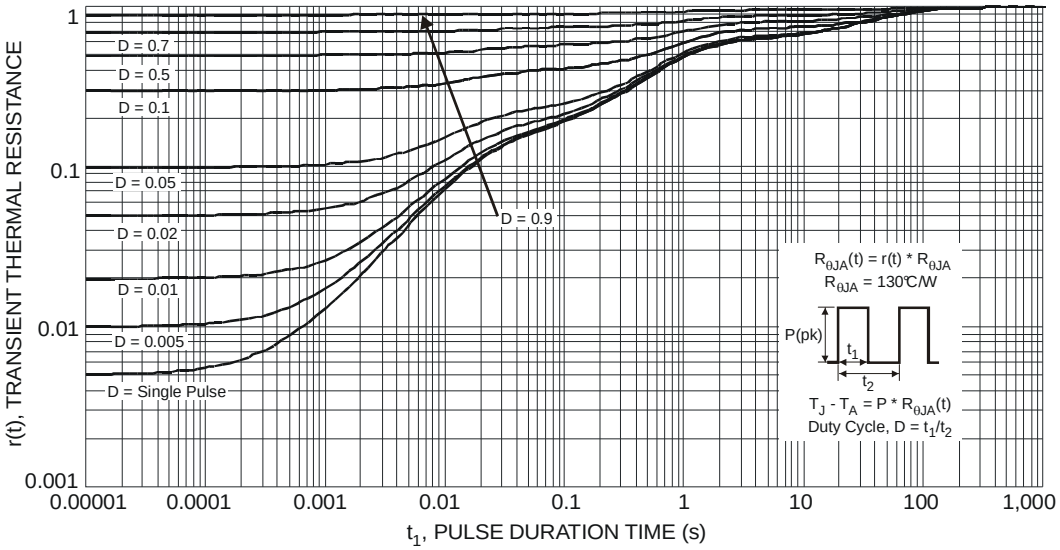


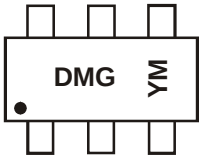
Fig. 11 Transient Thermal Response

Ordering Information (Note 7)

Part Number	Case	Packaging
DMG9926UDM-7	SOT-26	3000/Tape & Reel

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



DMG = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: W = 2009)
M = Month (ex: 9 = September)

Date Code Key

Year	2008	2009	2010	2011	2012	2013	2014	2015
Code	V	W	X	Y	Z	A	B	C

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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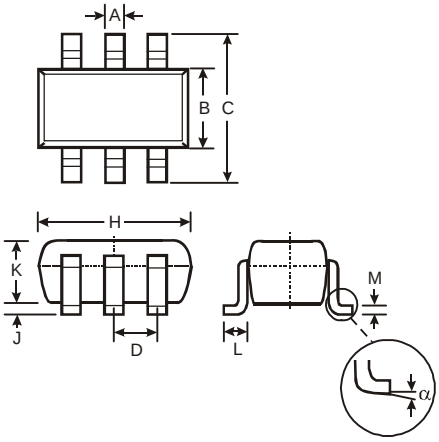
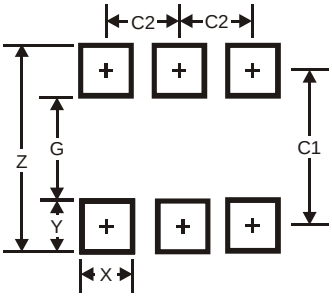
Package Outline Dimensions



SOT-26			
Dim	**Min**	**Max**	**Typ**
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

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